

CIS/SWA/SEA

LATIN

FDD 1/ 2/ 3/ 5/ 7/ 8/ 20/ 28

1/2/3/4/5/7/8/12/13/17/20/26/28/66

TDD 38/ 40/ 41

38/ 40/ 41

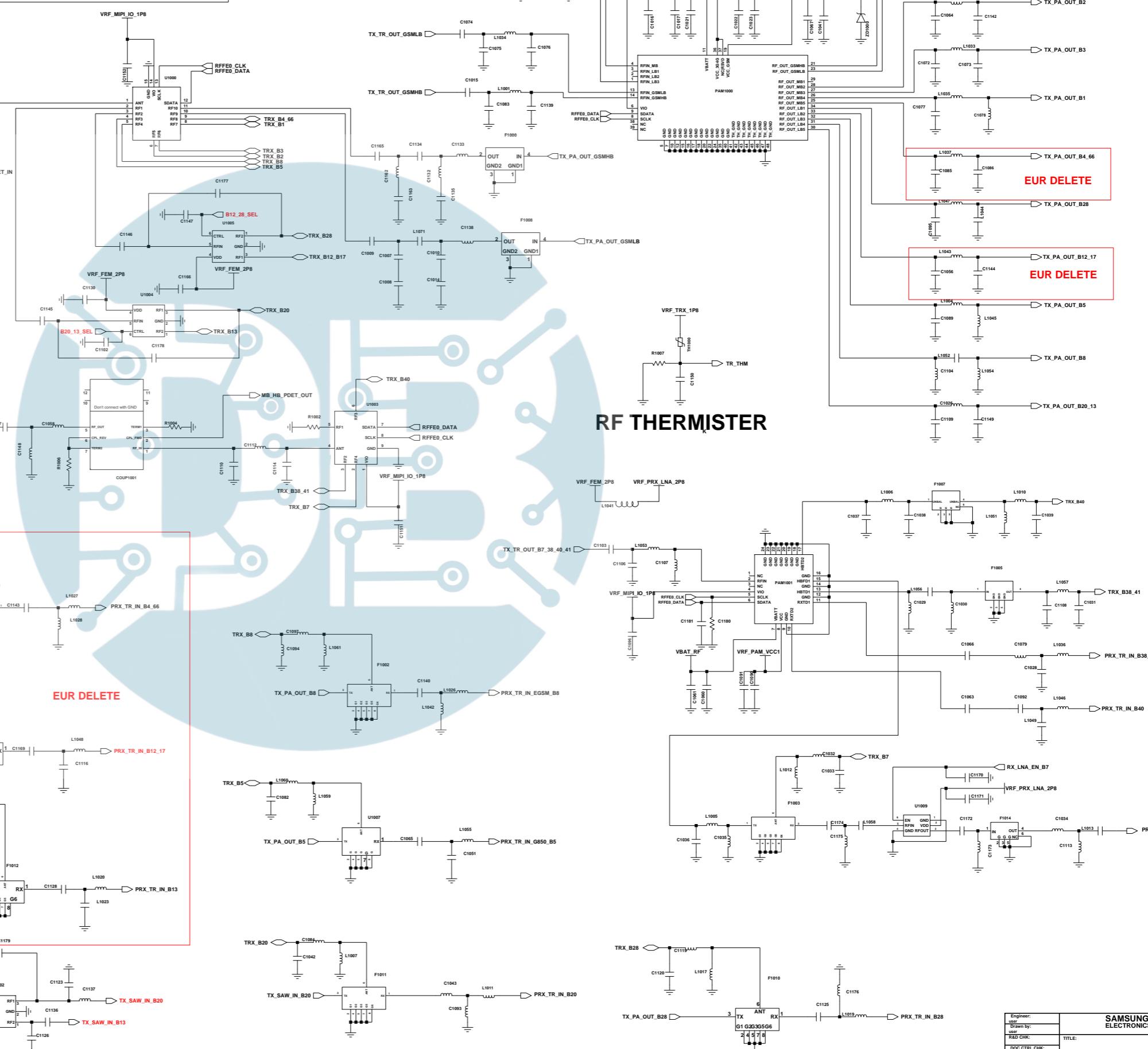
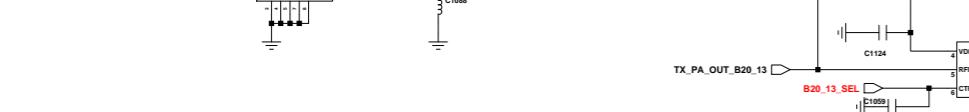
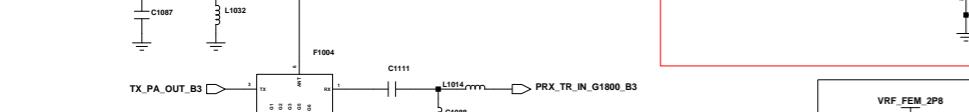
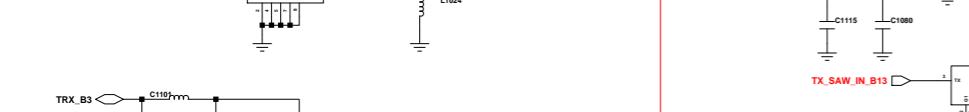
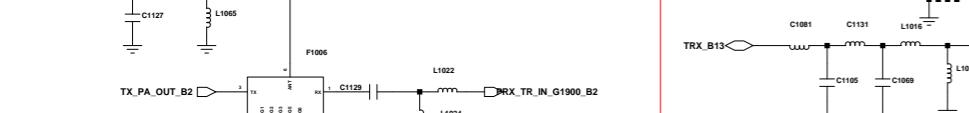
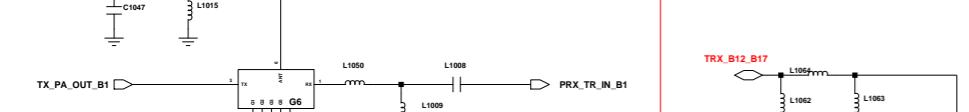
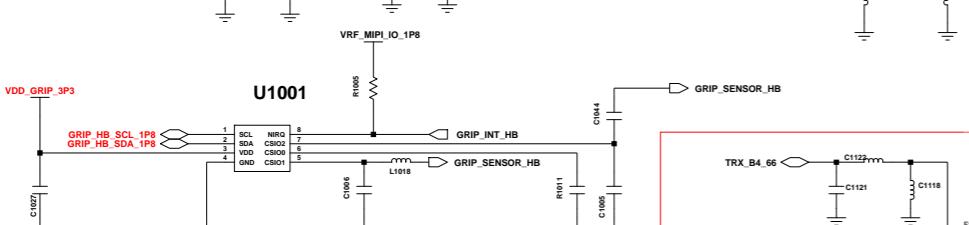
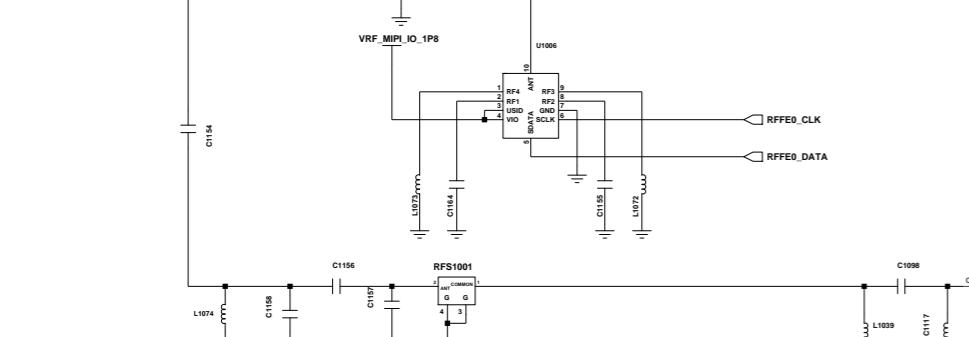
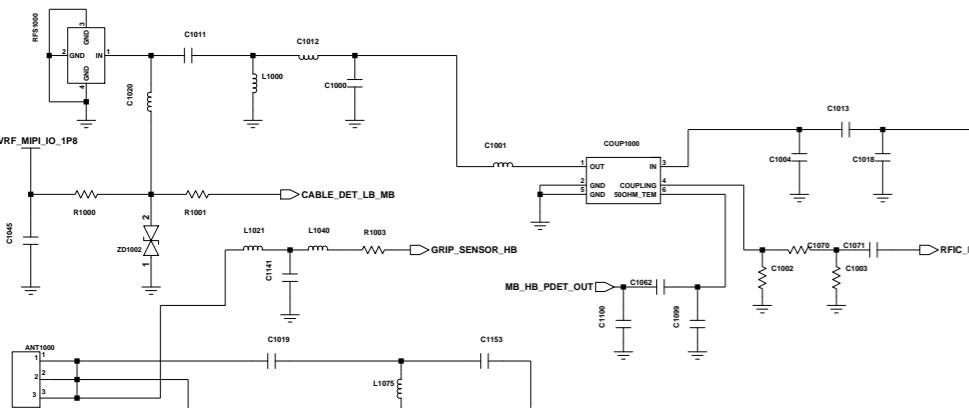
3G 1/ 2/ 5/ 8

1/2/4/5/8

2G 850/ 900/ 1800/ 1900

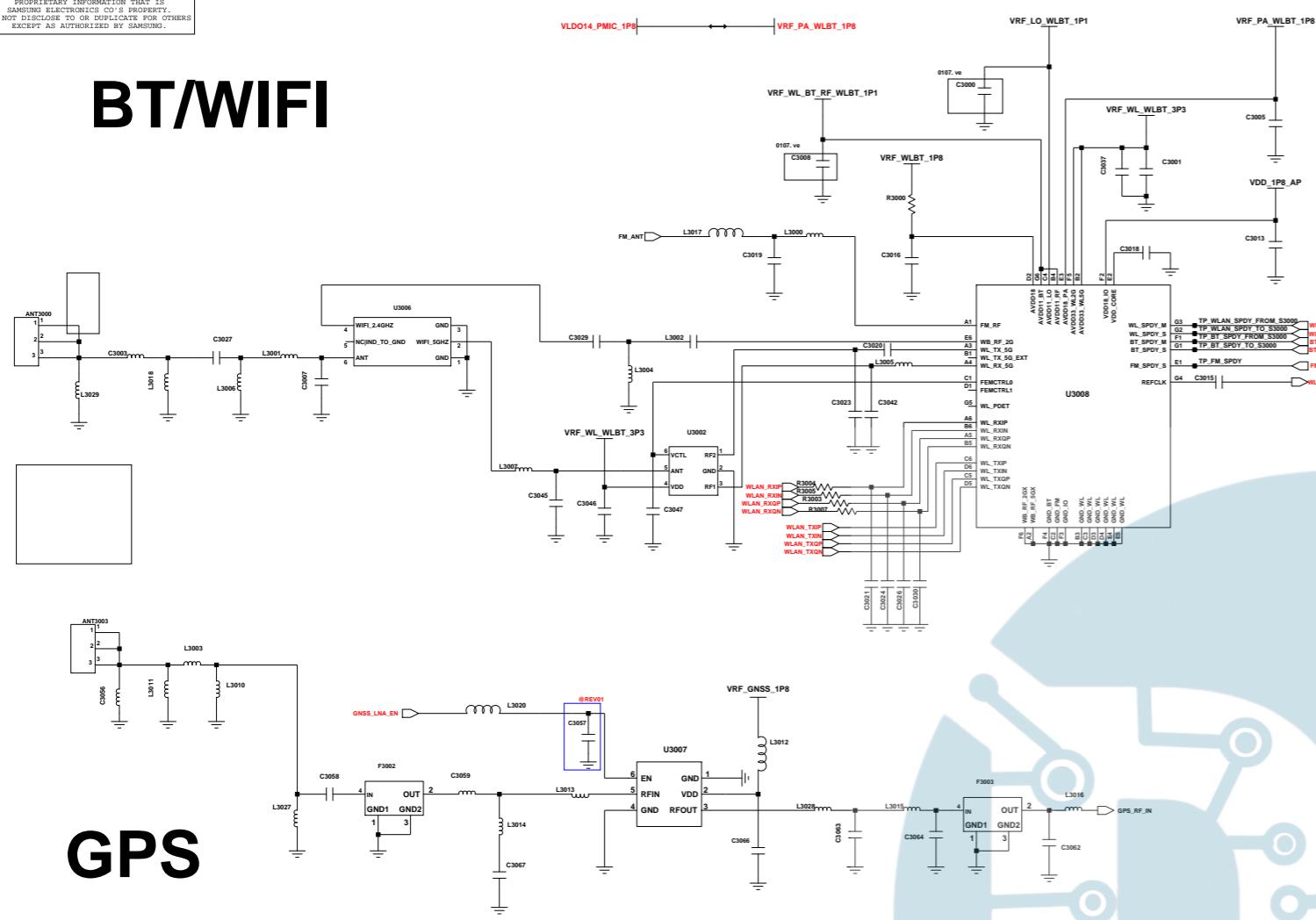
850/900/1800/1900

	CIS/SWA/SEA	LATIN
FDD	1/ 2/ 3/ 5/ 7/ 8/ 20/ 28	1/2/3/4/5/7/8/12/13/17/20/26/28/66
TDD	38/ 40/ 41	38/ 40/ 41
3G	1/ 2/ 5/ 8	1/2/4/5/8
2G	850/ 900/ 1800/ 1900	850/900/1800/1900



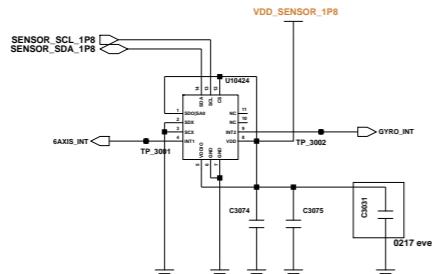
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BT/WIFI



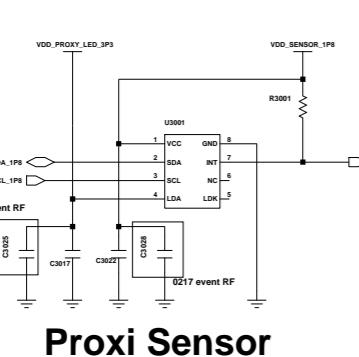
GPS

SENSORS



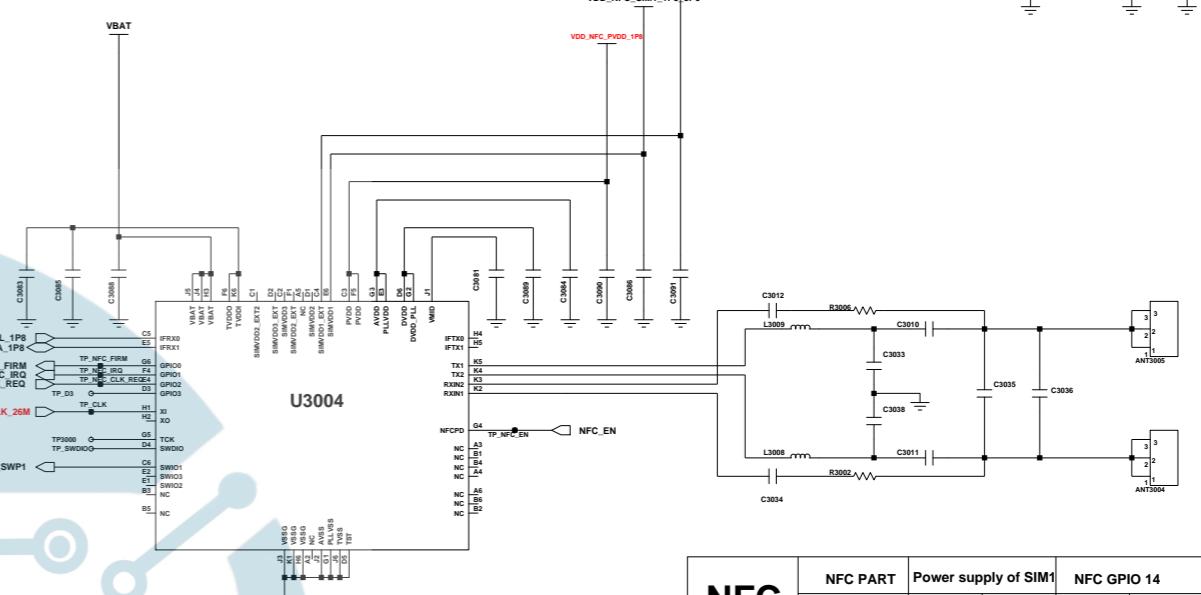
6 AXIS(ACC+GRYO)

STM(3x2)



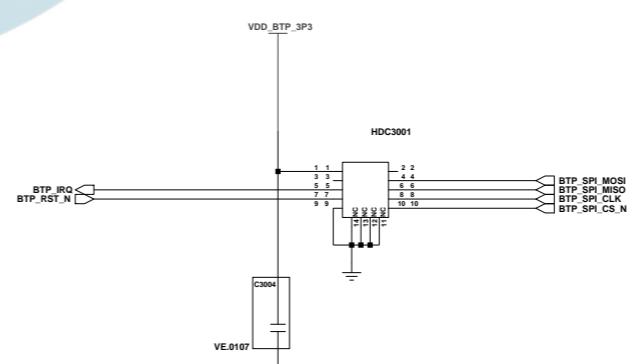
MAGNETIC

NFC(Option)



NFC	NFC PART	Power supply of SIM1		NFC GPIO 14	
	U3004	R5017	U7016	R4032	R4036
NFC	CONNECT	short	open	10K ohm	open
nonNFC	NC	open	short	open	10K ohm

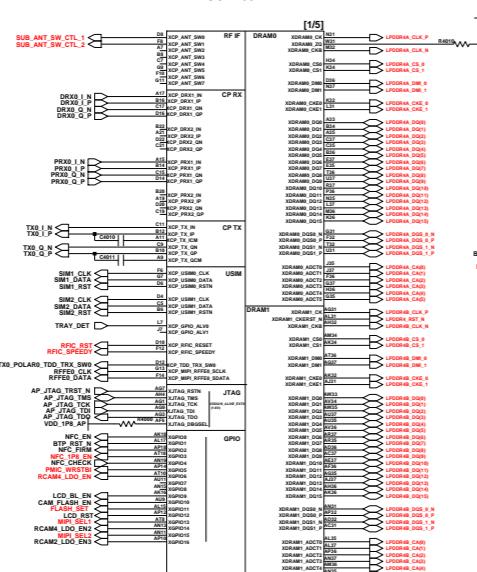
FINGER PRINT SENSOR



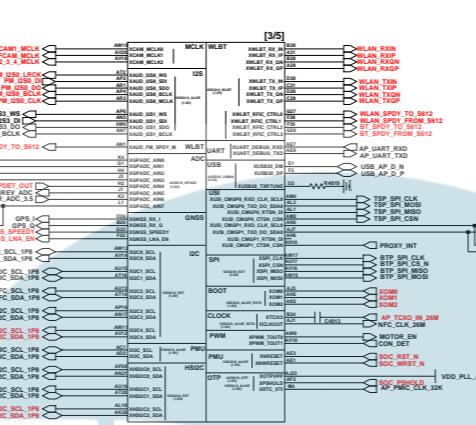
Finger Print Sensor

EXYNOS3830 (NACHO)

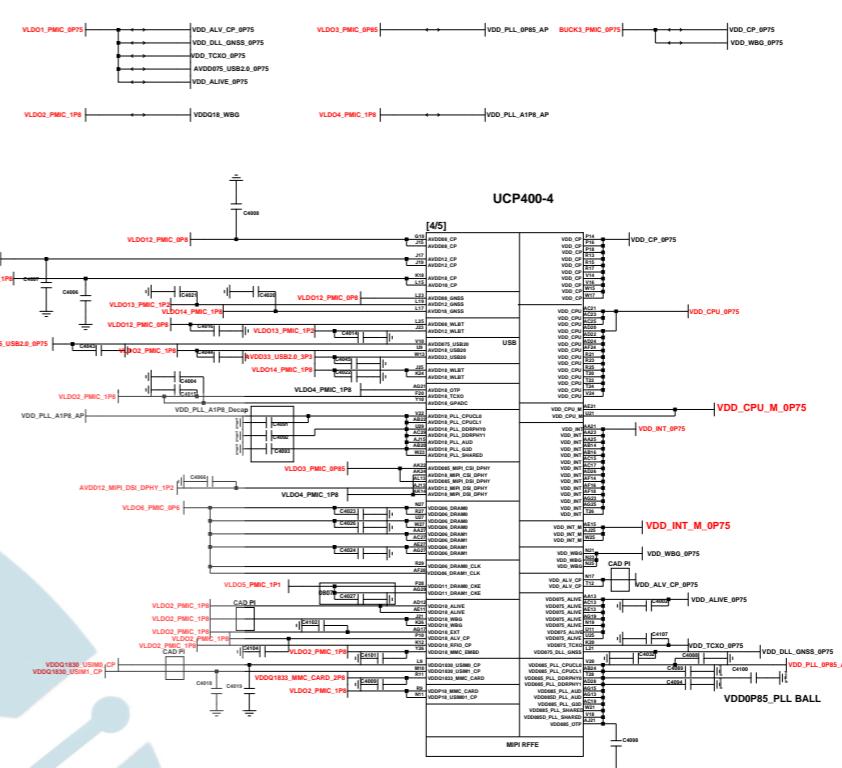
UCP400-1



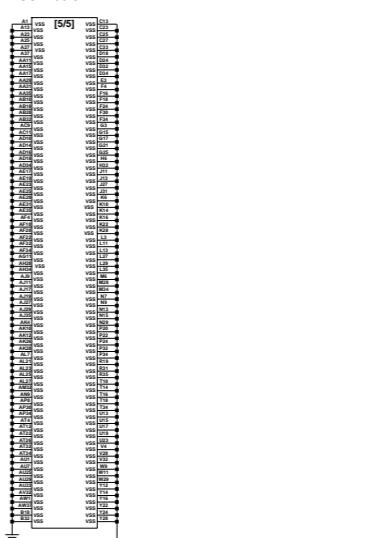
UCP400-3



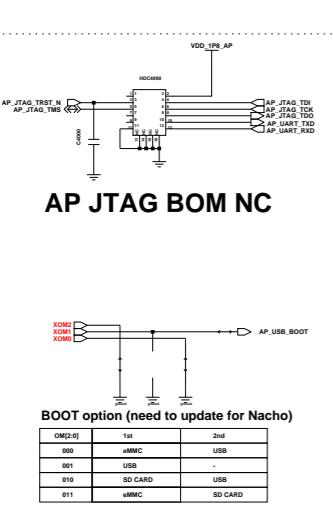
UCP400-4



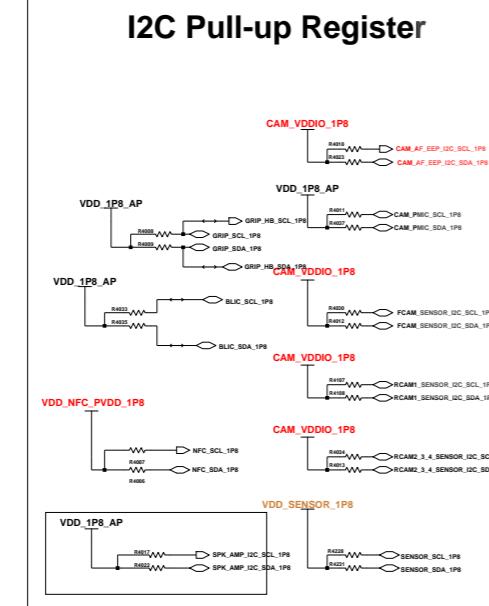
UCP400-5



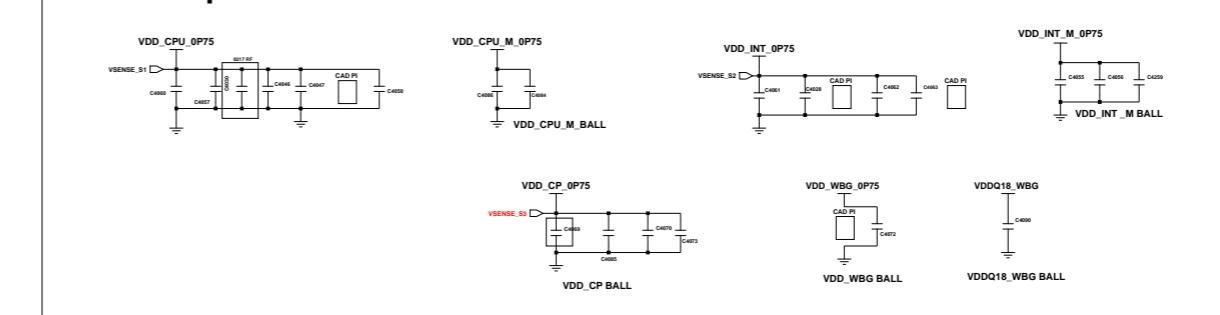
AP JTAG BOM NC



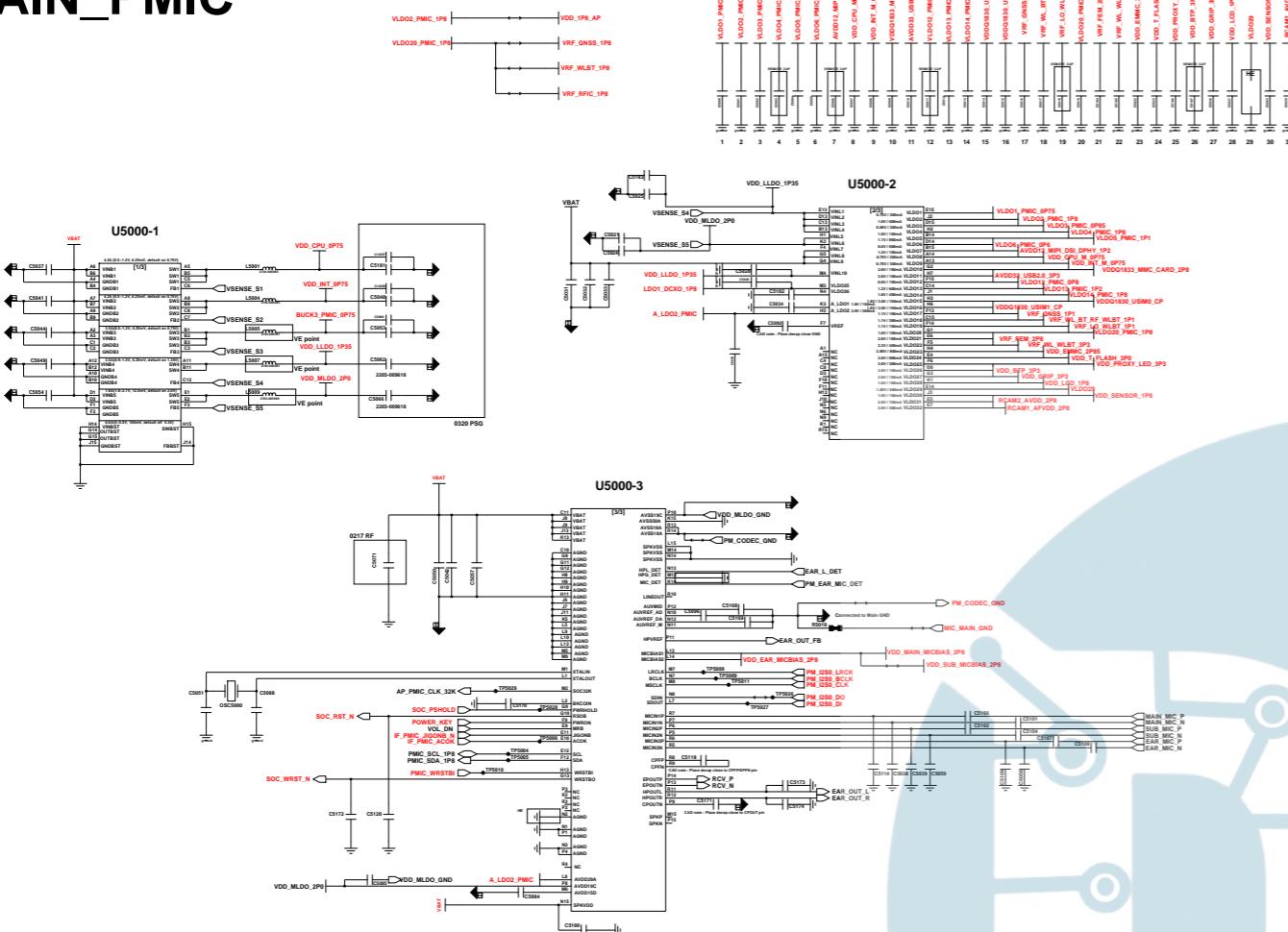
I2C Pull-up Register



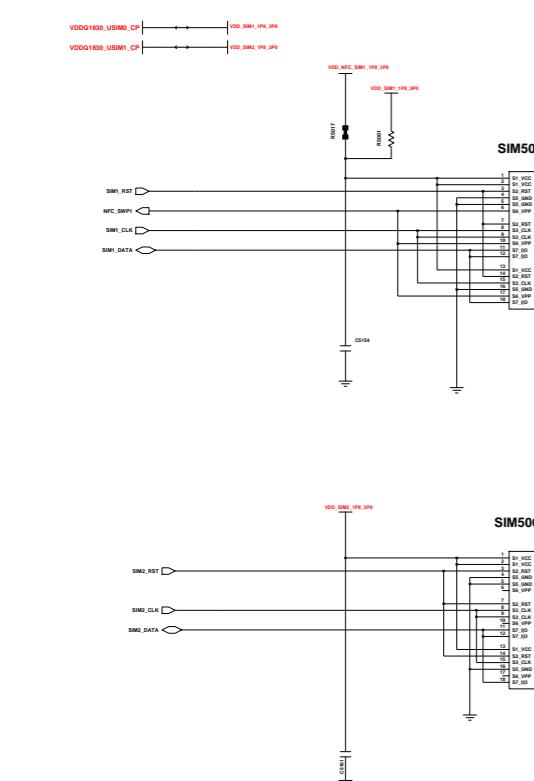
AP Decap



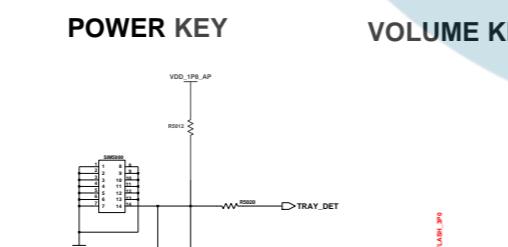
MAIN_PMIC



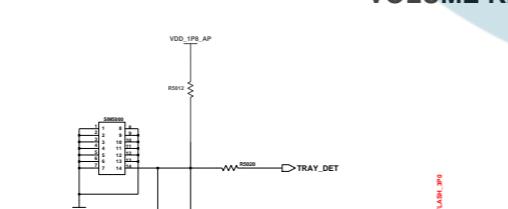
SIM & SD CARD (3IN3)



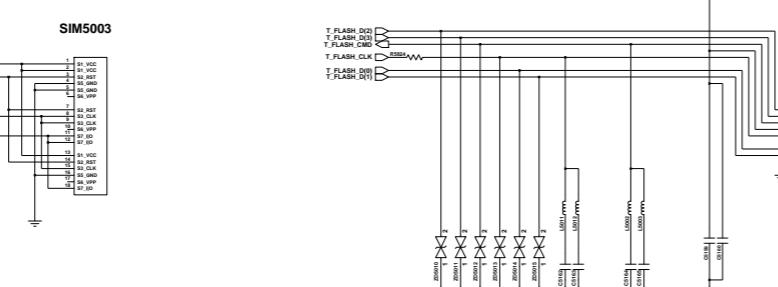
POWER K



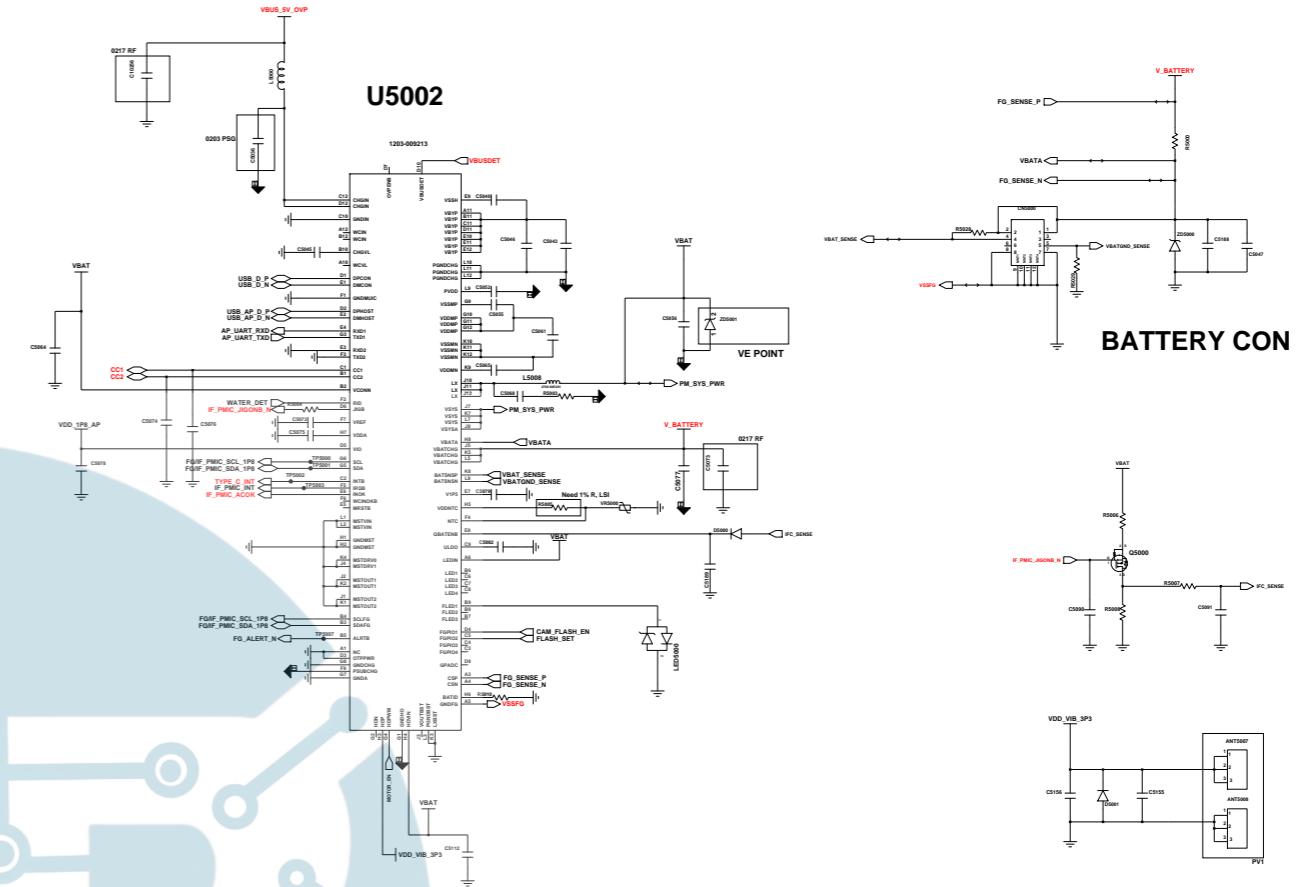
VOLUME K



SIM50

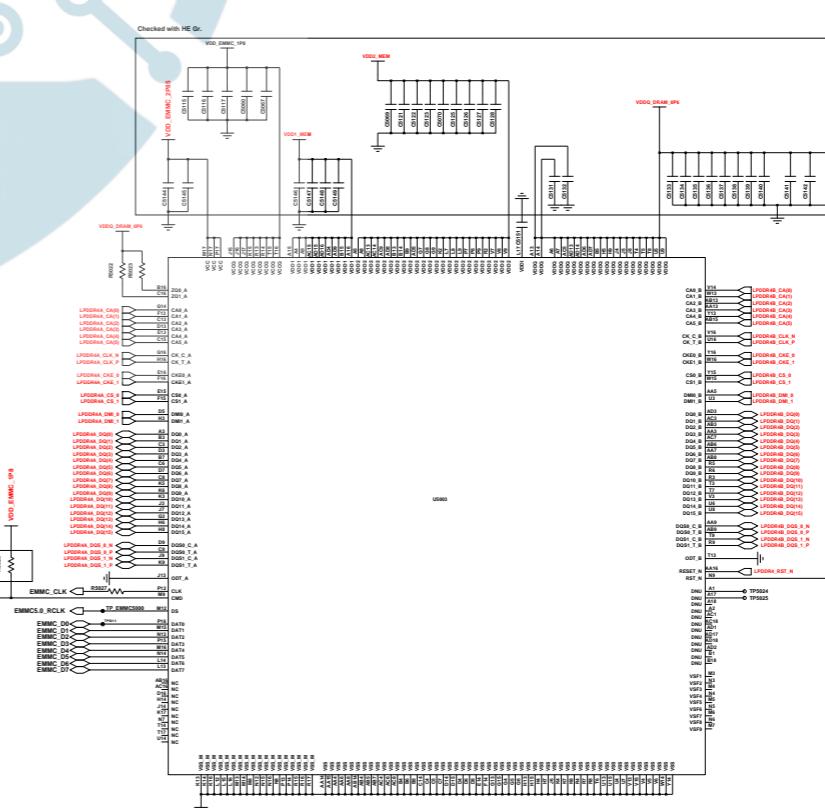


IF_PMI



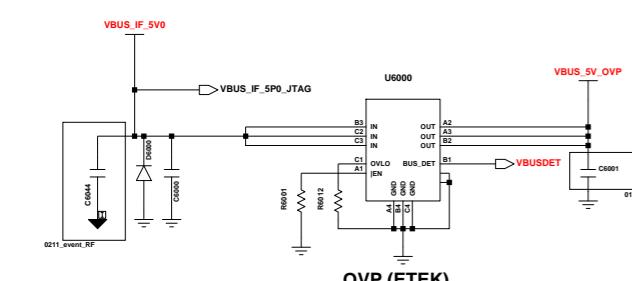
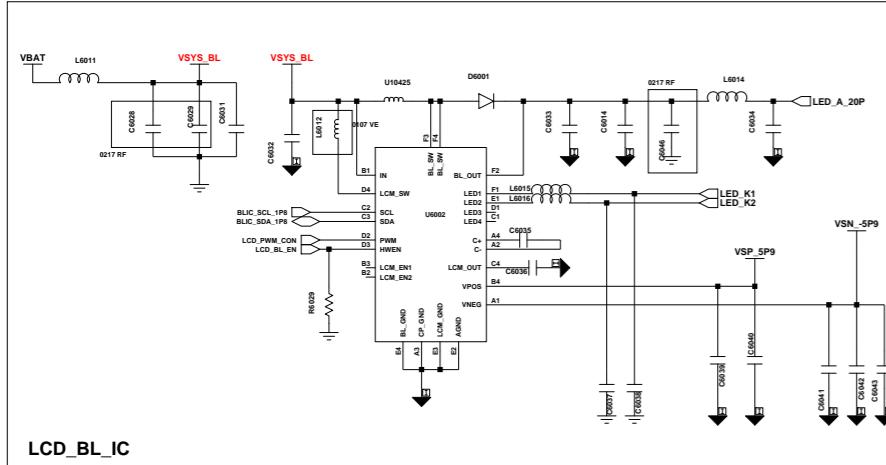
eMC

P * Default eMCP 3G LPDDR4 & 32GB eMMC 5.1 : 1108 - 000678
eMCP 4G LPDDR4 & 64GB eMMC 5.1 : 1108 - 000666
eMCP 6G LPDDR4 & 64GB eMMC 5.1 : 1108 - 000656

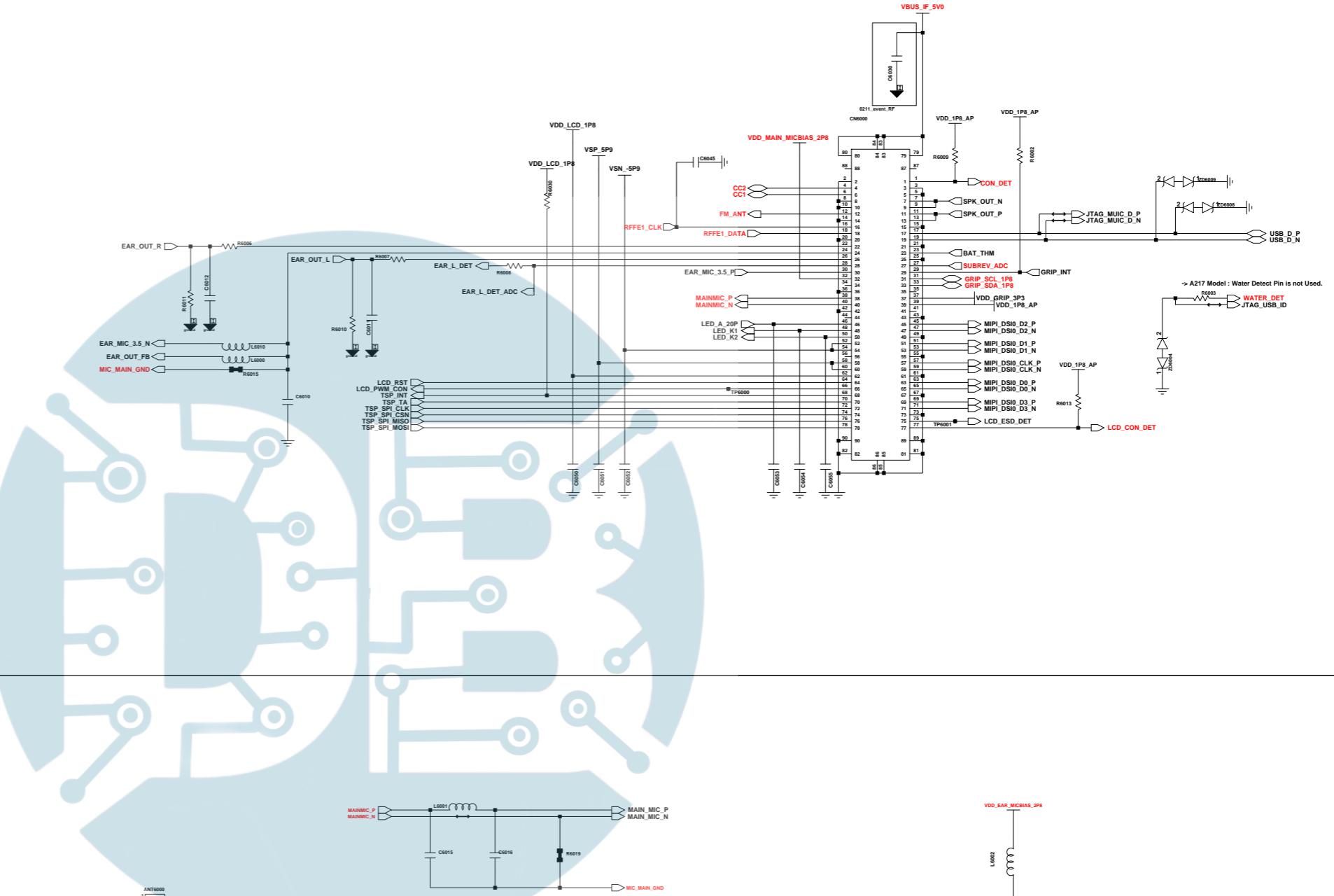


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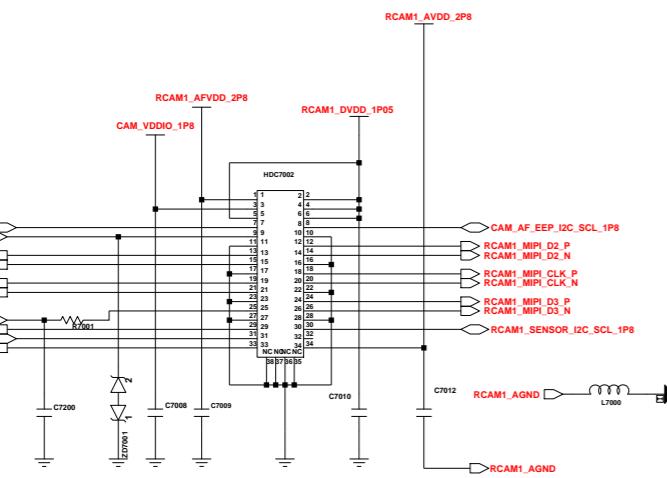
BLIC



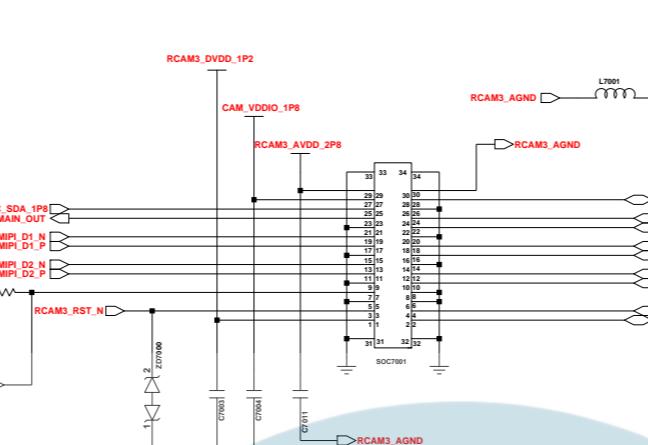
MAIN FPCB_PART (78pin) 6.55" HD+ TFT HID



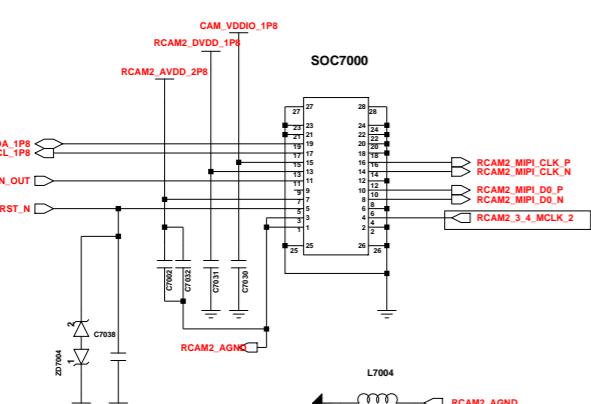
CAMERA_PART



RCAM1_48M_S5KGM2SP_34pin

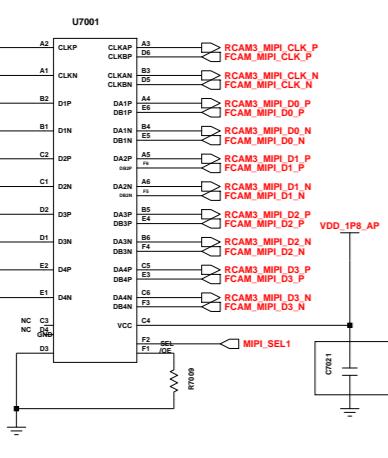


RCAM3_8M_UW_S5K4HAYX03_30pin

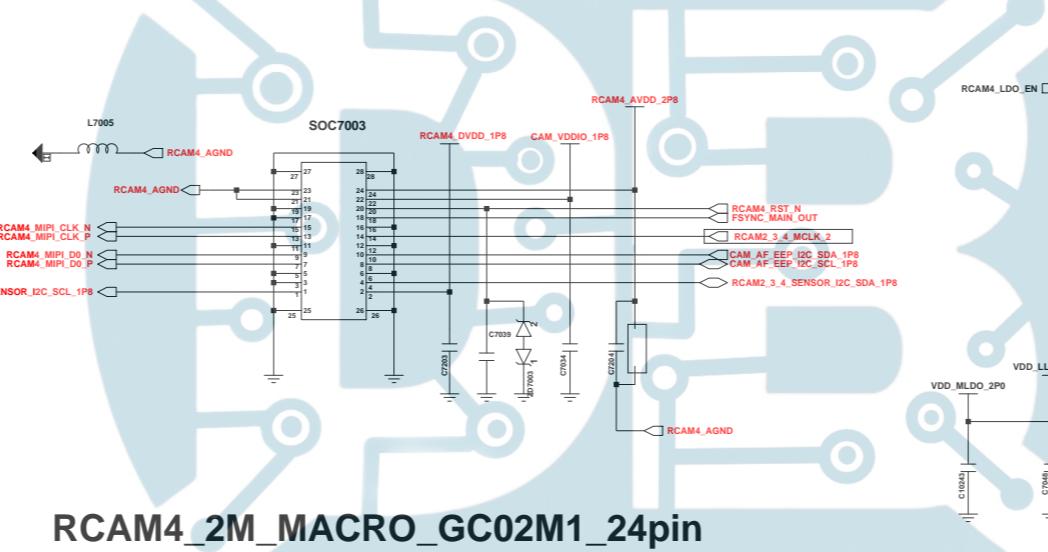


RCAM2_2M_BOKEH_GC02M1B_24pin

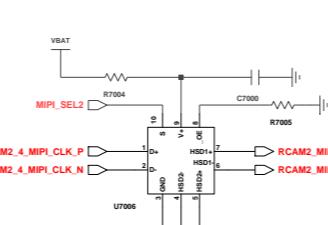
CAMERA MIPI SWITCH



VE point : Maxscend MIPI Switch



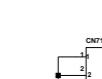
SHIELD CAN



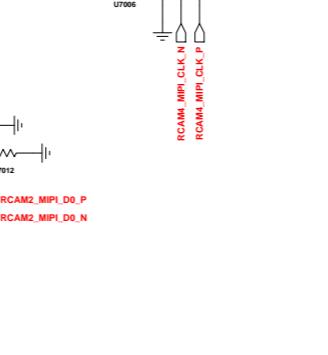
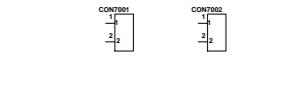
BOSS HOLE



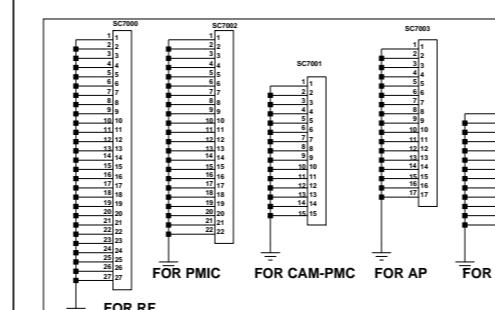
SMR Gasket



2D BARCODE



GND CONTACT



FOR OSC

FOR RF

FOR CAM-PMC

FOR AP

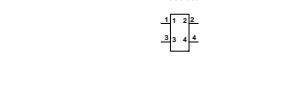
FOR DRX



F(GLOBAL)

M(LA)

N(KR)



MEMORY

3+32

4+64

6+64

R7003 R7006 R7007

O O O

REV Drawing Number: Page: 77

Engineer: Drawn by: Title: Size:
R&D CHK: REV Drawing Number: Page:
DOC CTRL CHK: MFG ENGR CHK:

CAMERA, DISPLAY

**SM-A217F/M
IREPAIR**

U3001

side_etching

side_etching

SC7003

U5003

UCP400

SIM5000

SIM5002

SIM5001

SIM5003

SC7001

300C/1001

HDC / 002

SOC7000

OTHZ000

BOTH7006

AHT7001

7182

BOTH70

307

CON7001

1

**SM-A217F/M
IREPAIR**

HDC4000 - NSR

SC7004

SOC7003

SC7002

U5000

U5002

SC7000

PAM1000

CN5000

CN6000

HDC3001

CONV002

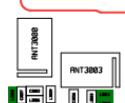
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HDC4000

ANT6001

ANT6002



SOC7002

C7147

L7001 L7002

RH1380C RH1380B

RFS1001

RH11000

RFS1002

+

SUS7000

DS5001

PM2001

PM2002

PM2003

PM2004

PM2005

PM2006

PM2007

PM2008

PM2009

PM2010

PM2011

PM2012

PM2013

PM2014

PM2015

PM2016

PM2017

PM2018

PM2019

PM2020

PM2021

PM2022

+